BLF6G22LS-100

Power LDMOS transistor

AMPLEON

Rev. 4 — 1 September 2015

Product data sheet

1. Product profile

1.1 General description

100 W LDMOS power transistor for base station applications at frequencies from 2000 MHz to 2200 MHz.

Table 1. Typical performance

RF performance at T_{case} = 25 °C in a common source class-AB production test circuit.

Mode of operation	f	V _{DS}	P _{L(AV)}	Gp	η _D	IMD3	ACPR
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)	(dBc)
2-carrier W-CDMA	2110 to 2170	28	25	18.2	29	-37 <mark>[1]</mark>	-41 <mark>[1]</mark>

^[1] Test signal: 3GPP; test model 1; 64 DPCH; PAR = 7 dB at 0.01 % probability on CCDF per carrier; carrier spacing 10 MHz.

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Typical 2-carrier W-CDMA performance at frequencies of 2110 MHz and 2170 MHz, a supply voltage of 28 V and an I_{Dq} of 950 mA:
 - ◆ Average output power = 25 W
 - ◆ Gain = 18.2 dB
 - ◆ Efficiency = 29 %
 - ◆ IMD3 = -37 dBc
 - ◆ ACPR = -41 dBc
- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (2000 MHz to 2200 MHz)
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

■ RF power amplifiers for W-CDMA base stations and multi carrier applications in the 2000 MHz to 2200 MHz frequency range

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	drain		
2	gate	1 1	1 لـــا
3	source		2 3 3 sym112

^[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package	ackage				
	Name	Description	Version			
BLF6G22LS-100	-	earless flanged LDMOST ceramic package; 2 leads	SOT502B			

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
V_{GS}	gate-source voltage		-0.5	+13	V
I_D	drain current		-	29	Α
T_{stg}	storage temperature		-65	+150	°C
T _j	junction temperature		-	225	°C

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{\text{th(j-case)}}$	thermal resistance from junction to case	T_{case} = 80 °C; P_L = 25 W	0.43	K/W

6. Characteristics

Table 6. Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 0.5 \text{ mA}$	65	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	V_{DS} = 10 V; I_{D} = 150 mA	1.4	1.9	2.4	V
V_{GSq}	gate-source quiescent voltage	V_{DS} = 28 V; I_{D} = 900 mA	1.76	2.26	2.76	V
I _{DSS}	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V}$	-	-	5	μΑ
I_{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 V;$ $V_{DS} = 10 V$	22	28	-	Α
I _{GSS}	gate leakage current	$V_{GS} = 11 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	450	nA
9fs	forward transconductance	$V_{DS} = 10 \text{ V}; I_D = 7.5 \text{ A}$	-	11	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 V;$ $I_D = 5.25 A$	-	0.1	0.16	Ω
C _{rs}	feedback capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V};$ f = 1 MHz	-	2.1	-	pF

7. Application information

Table 7. Application information

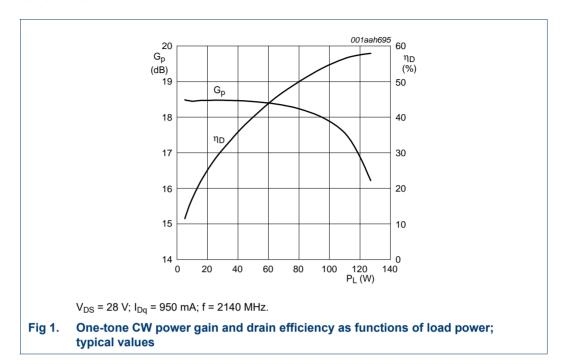
Mode of operation: 2-carrier W-CDMA; PAR 7 dB at 0.01 % probability on CCDF; 3GPP test model 1; 1-64 PDPCH; f_1 = 2112.5 MHz; f_2 = 2122.5 MHz; f_3 = 2157.5 MHz; f_4 = 2167.5 MHz; RF performance at V_{DS} = 28 V; I_{Dq} = 950 mA; T_{case} = 25 °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$P_{L(AV)}$	average output power		-	25	-	W
G_p	power gain	$P_{L(AV)} = 25 W$	17	18.2	-	dB
IRL	input return loss	$P_{L(AV)} = 25 W$	-	-9	-7	dB
η_{D}	drain efficiency	P _{L(AV)} = 25 W	27.5	29	-	%
IMD3	third-order intermodulation distortion	P _{L(AV)} = 25 W	-	-37	-34.5	dBc
ACPR	adjacent channel power ratio	P _{L(AV)} = 25 W	-	-41	-38.5	dBc

7.1 Ruggedness in class-AB operation

The BLF6G22LS-100 is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 28 V; I_{Dq} = 950 mA; P_{L} = 100 W (CW); f = 2170 MHz.

7.2 One-tone CW



7.3 Two-tone CW

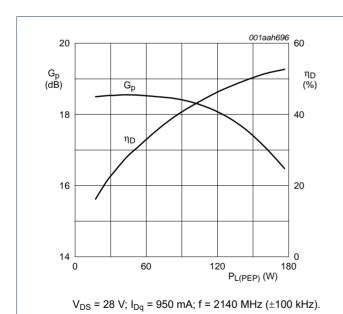


Fig 2. Two-tone CW power gain and drain efficiency as functions of peak envelope load power; typical values

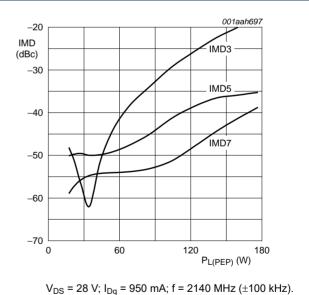
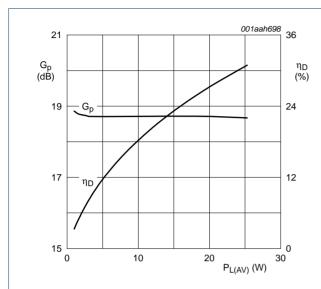


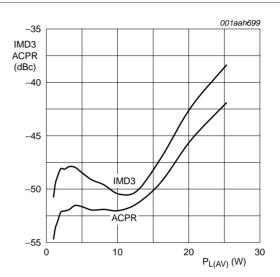
Fig 3. Two-tone CW intermodulation distortion as function of peak envelope load power; typical values

7.4 2-carrier W-CDMA



 V_{DS} = 28 V; I_{Dq} = 950 mA; f = 2140 MHz (± 5 MHz); carrier spacing 10 MHz.

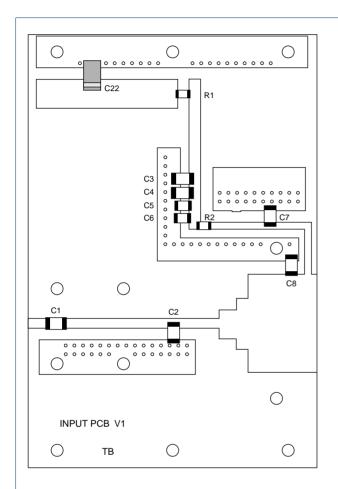
Fig 4. 2-carrier W-CDMA power gain and drain efficiency as functions of average load power; typical values

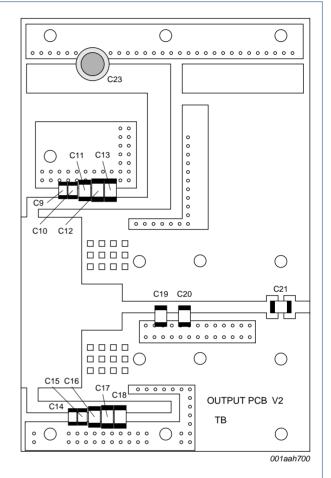


 V_{DS} = 28 V; I_{Dq} = 950 mA; f = 2140 MHz (± 5 MHz); carrier spacing 10 MHz.

Fig 5. 2-carrier W-CDMA adjacent channel power ratio and third order intermodulation distortion as functions of average load power; typical values

8. Test information





The striplines are on a double copper-clad Taconic RF35 Printed-Circuit Board (PCB) with ε_r = 3.5 and thickness = 0.76 mm. See Table 8 for list of components.

The drawing is not to scale.

Fig 6. Component layout

Table 8. List of components (see Figure 6)

Component	Description	Value	Remarks
C1	multilayer ceramic chip capacitor	5.6 pF	[1]
C2	multilayer ceramic chip capacitor	1.0 pF	[1]
C3, C4, C12, C13, C17, C18	multilayer ceramic chip capacitor	1.5 μF	SMD 0805; TDK or capacitor of same quality
C5, C6, C10, C15	multilayer ceramic chip capacitor	100 nF	SMD 0603; Murata or capacitor of same quality
C7	multilayer ceramic chip capacitor	1.5 pF	[1]
C8	multilayer ceramic chip capacitor	0.6 pF	[1]

Table 8. List of components (see Figure 6) ...continued

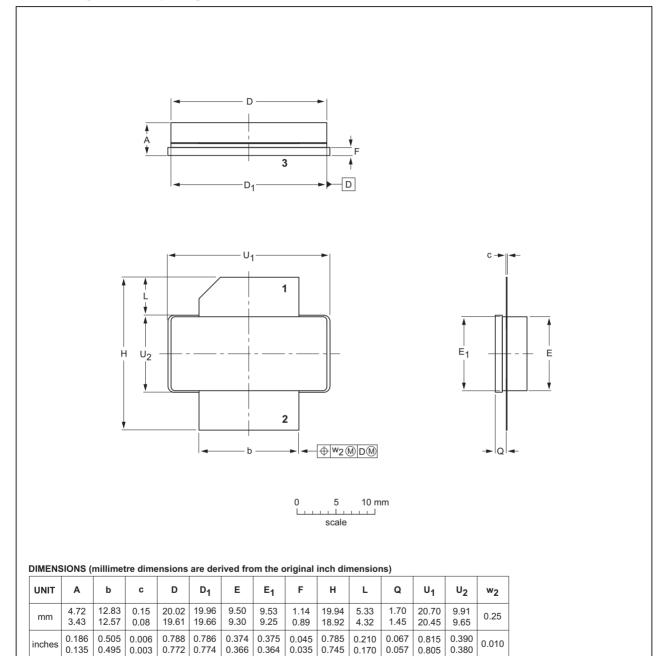
Component	Description	Value		Remarks
C9, C14	multilayer ceramic chip capacitor	220 nF		SMD 1206; AVX or capacitor of same quality
C11, C16	multilayer ceramic chip capacitor	10 pF	[1]	
C19	multilayer ceramic chip capacitor	1.1 pF	[1]	
C20	multilayer ceramic chip capacitor	0.5 pF	[1]	
C21	multilayer ceramic chip capacitor	20 pF	[1]	
C22	tantalum capacitor	10 μF; 35 V		
C23	electrolytic capacitor	220 μF; 35 V		
R1	SMD resistor	3.6 Ω		
R2	SMD resistor	5.1 Ω		

^[1] American Technical Ceramics type 100B or capacitor of same quality.

Package outline

Earless flanged ceramic package; 2 leads

SOT502B



OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT502B					07-05-09 12-05-02

0.057

0.805

0.380

Package outline SOT502B Fig 7.

0.135

0.495

0.003

10. Abbreviations

Table 9. Abbreviations

Acronym	Description			
3GPP	Third Generation Partnership Project			
CCDF	Complementary Cumulative Distribution Function			
CW	Continuous Wave			
DPCH	Dedicated Physical CHannel			
LDMOS	Laterally Diffused Metal Oxide Semiconductor			
LDMOST	Laterally Diffused Metal-Oxide Semiconductor Transistor			
PAR	Peak-to-Average power Ratio			
PDPCH	transmission Power of the Dedicated Physical CHannel			
RF	Radio Frequency			
VSWR	Voltage Standing Wave Ratio			
W-CDMA	Wideband Code Division Multiple Access			

11. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
BLF6G22LS-100#4	20150901	Product data sheet	-	BLF6G22LS-100 v.3			
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. Legal texts have been adapted to the new company name where appropriate. 						
BLF6G22LS-100 v.3	20101112	Product data sheet	-	BLF6G22LS-100 v.2			
BLF6G22LS-100 v.2	20100331	Product data sheet	-	BLF6G22LS-100 v.1			
BLF6G22LS-100 v.1	20080218	Preliminary data sheet	-	-			

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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BLF6G22LS-100

Power LDMOS transistor

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